

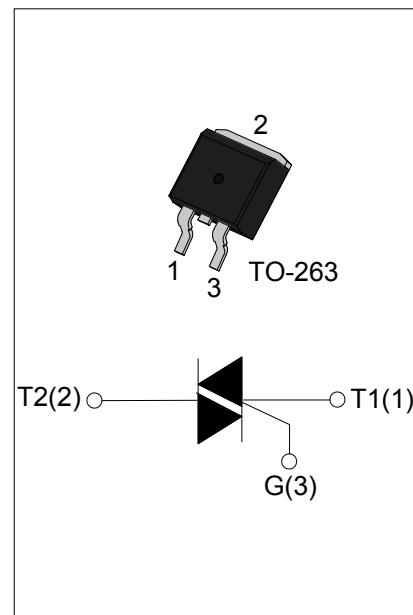


## JST20E 20A TRIACs

Rev.7.0

## DESCRIPTION:

With high ability to withstand the shock loading of large current, JST20E triacs provides high dv/dt rate with strong resistance to electromagnetic interface. With high commutation performances, 3 quadrants products especially recommended for use on inductive load. TO-263 Package is RoHS compliant. (2011/65/EU)



## MAIN FEATURES

Symbol	Value	Unit
$I_{T(RMS)}$	20	A
$V_{DRM}/V_{RRM}$	600/800/1200	V

## ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Storage junction temperature range	$T_{stg}$	-40-150	°C
Operating junction temperature range	$T_j$	-40-125	°C
Repetitive peak off-state voltage ( $T_j=25^\circ\text{C}$ )	$V_{DRM}$	600/800/1200	V
Repetitive peak reverse voltage ( $T_j=25^\circ\text{C}$ )	$V_{RRM}$	600/800/1200	V
Non repetitive surge peak Off-state voltage	$V_{DSM}$	$V_{DRM} + 100$	V
Non repetitive peak reverse voltage	$V_{RSM}$	$V_{RRM} + 100$	V
RMS on-state current TO-263 ( $T_c=65^\circ\text{C}$ )	$I_{T(RMS)}$	20	A
Non repetitive surge peak on-state current (full cycle, $f=50\text{Hz}$ )	$I_{TSM}$	200	A
$I^2t$ value for fusing ( $t_p=10\text{ms}$ )	$I^2t$	200	$\text{A}^2\text{s}$
Critical rate of rise of on-state current ( $I_G = 2 \times I_{GT}$ )	$dI/dt$	100	$\text{A}/\mu\text{s}$
Peak gate current	$I_{GM}$	4	A
Average gate power dissipation	$P_{G(AV)}$	1	W
Peak gate power	$P_{GM}$	10	W

ELECTRICAL CHARACTERISTICS ( $T_j=25^\circ\text{C}$  unless otherwise specified)

## 3 Quadrants

Symbol	Test Condition	Quadrant	Value		Unit
			BW	CW	
$I_{GT}$	$V_D = 12V$ $R_L = 33\Omega$	I - II - III	MAX	50	mA
$V_{GT}$		I - II - III	MAX	1.3	
$V_{GD}$	$V_D = V_{DRM}$ $T_j = 125^\circ\text{C}$ $R_L = 3.3\text{K}\Omega$	I - II - III	MIN	0.2	
$I_L$	$I_G = 1.2I_{GT}$	I - III	MAX	70	mA
		II		90	70
$I_H$	$I_T = 100\text{mA}$		MAX	60	50
dV/dt	$V_D = 2/3V_{DRM}$ Gate Open $T_j = 125^\circ\text{C}$		MIN	1000	500
					$\text{V}/\mu\text{s}$

## 4 Quadrants

Symbol	Test Condition	Quadrant		Value	Unit
$I_{GT}$	$V_D = 12V$ $R_L = 33\Omega$	I - II - III	MAX	50	mA
		IV		70	
$V_{GT}$		ALL	MAX	1.3	V
$V_{GD}$	$V_D = V_{DRM}$ $T_j = 125^\circ\text{C}$ $R_L = 3.3\text{K}\Omega$	ALL	MIN	0.2	V
$I_L$	$I_G = 1.2I_{GT}$	I - III - IV	MAX	70	mA
		II		90	
$I_H$	$I_T = 100\text{mA}$		MAX	60	mA
dV/dt	$V_D = 2/3V_{DRM}$ Gate Open $T_j = 125^\circ\text{C}$		MIN	500	$\text{V}/\mu\text{s}$

## STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
$V_{TM}$	$I_{TM} = 28\text{A}$ $tp = 380\mu\text{s}$		$T_j = 25^\circ\text{C}$	1.5
$I_{DRM}$	$V_D = V_{DRM}$ $V_R = V_{RRM}$	$T_j = 25^\circ\text{C}$	5	$\mu\text{A}$
$I_{RRM}$		$T_j = 125^\circ\text{C}$	2.5	mA

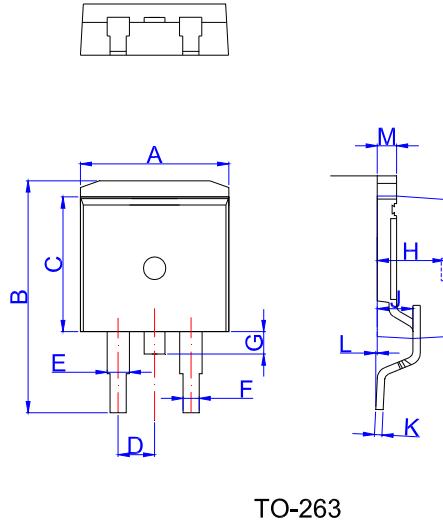
## THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	junction to case(AC)	2.5	$^{\circ}\text{C}/\text{W}$
$R_{th(j-a)}$		45	

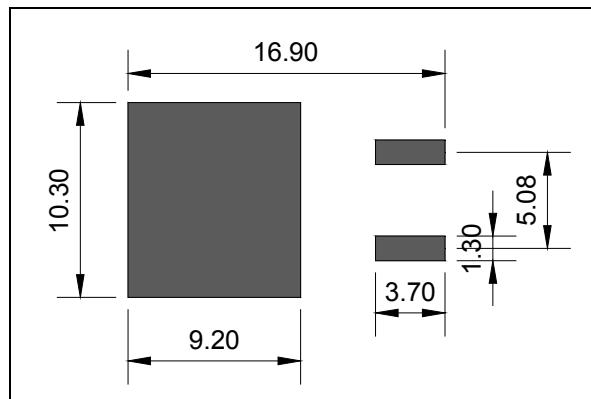
## ORDERING INFORMATION

J	ST	20	E	-600	BW
JieJie Microelectronics Co.,Ltd					$\text{BW: } I_{GT1-3} \leq 50\text{mA}$
					$\text{CW: } I_{GT1-3} \leq 35\text{mA}$
					$\text{B: } I_{GT1-3} \leq 50\text{mA } I_{GT4} \leq 70\text{mA}$
					$600: V_{DRM} / V_{RRM} \geq 600\text{V}$
					$800: V_{DRM} / V_{RRM} \geq 800\text{V}$
					$1200: V_{DRM} / V_{RRM} \geq 1200\text{V}$
					E:TO-263 ETR:TO-263(Tape&Reel)

## PACKAGE MECHANICAL DATA

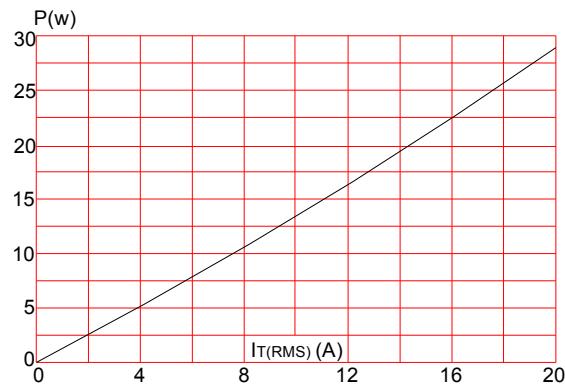


Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	9.90		10.20	0.390		0.402
B	14.70		15.80	0.579		0.622
C	9.4		9.6	0.37		0.378
D		2.54			0.100	
E	1.20		1.40	0.047		0.055
F	0.75		0.85	0.029		0.033
G			1.75			0.069
H	4.40		4.70	0.173		0.185
J	2.30		2.70	0.091		0.106
K	0.38		0.55	0.015		0.022
L	0	0.10	0.25	0	0.004	0.010
M	1.25		1.35	0.049		0.053

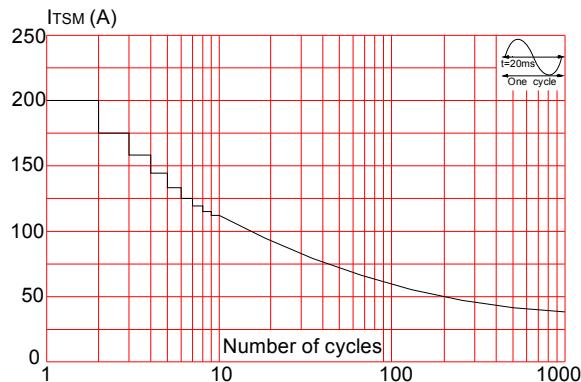
**FOOTPRINT-TO-263 (dimensions in mm)****PACKAGE INFORMATION**

PACKAGE	OUTLINE	TUBE (PCS)	INNER BOX (PCS)	PER CARTON
TO-263	TUBE	50	1,000	8,000
PACKAGE	OUTLINE	REEL (PCS)	PER CARTON (PCS)	TAPE & REEL
TO-263	TAPING	800	4,000	13 inch

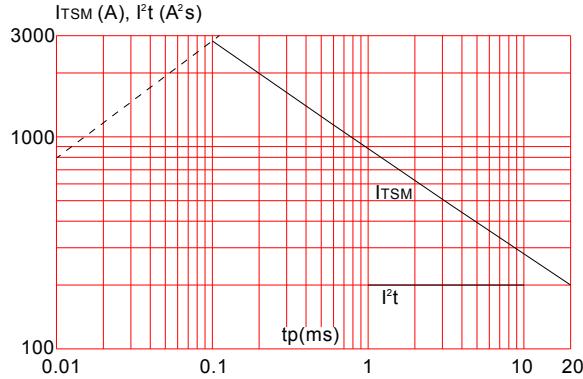
**FIG.1** Maximum power dissipation versus RMS on-state current



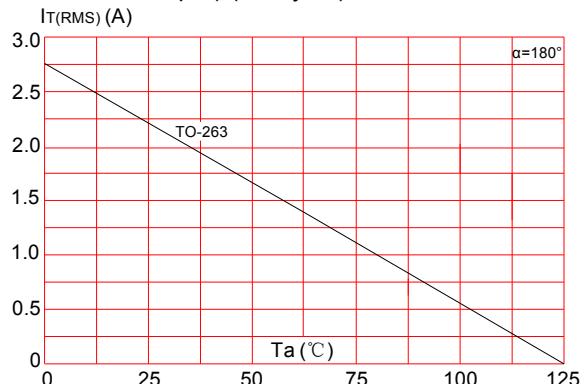
**FIG.3:** Surge peak on-state current versus number of cycles



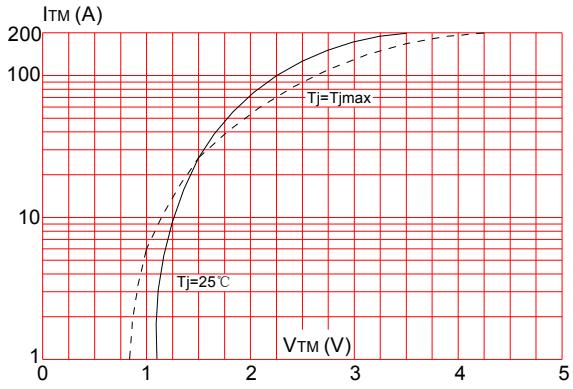
**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 20\text{ms}$ , and corresponding value of  $I^2t$  ( $dI/dt < 100\text{A}/\mu\text{s}$ )



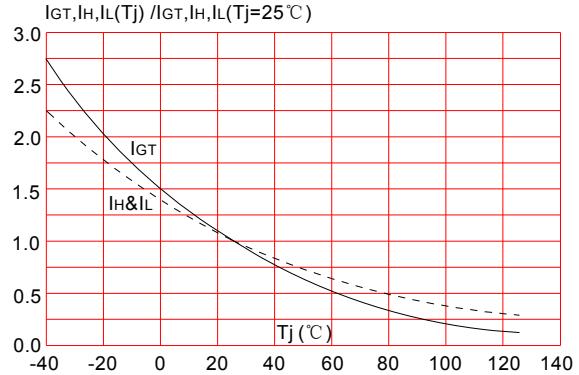
**FIG.2:** RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35μm) (full cycle)



**FIG.4:** On-state characteristics (maximum values)

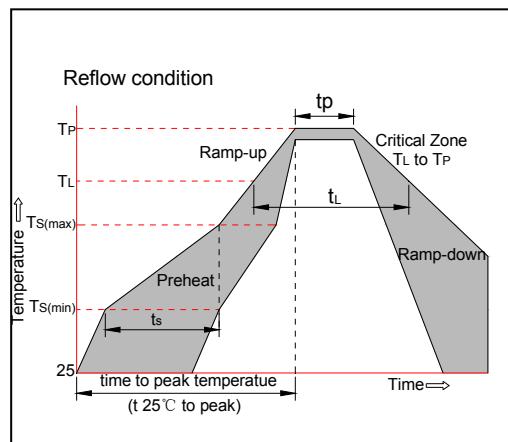


**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature



## SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see figure at right)
Pre Heat	-Temperature Min ( $T_{S(\min)}$ )	+150°C
	-Temperature Max( $T_{S(\max)}$ )	+200°C
	-Time (Min to Max) ( $t_s$ )	60-180 secs.
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{S(\max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ ) (Liquidus)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		20-40secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_p$ )		8 min. Max
Do not exceed		+260°C



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